



BU9-98-110DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re patent application of
Armbrust et al.

Serial No.: 09/666,325

Filed: September 21, 2000

For: SELF-ALIGNED COPPER SILICIDE FORMATION FOR IMPROVED
ADHESION/ELECTROMIGRATION

Assistant Commissioner of Patents
Washington, D.C. 20231

Group Art Unit: 2811
Examiner: Kang, D.

6/B
1-Step for
4/3/01

TECHNOLOGY CENTER 2800

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MAR -1, 2001

Sir:

AMENDMENT UNDER 37 C.F.R. §1.111

In response to the Office Action mailed January 2, 2001, please amend the above-
identified patent application as follows:

IN THE CLAIMS:

Please add the following new claims: